

**APPLICATION DATA SHEET****Inventor Information**

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Country of Residence	:	USA
Citizenship Country	:	USA
Inventor Two Given Name	:	Lee
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Country of Residence	:	USA
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**Correspondence Information**

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### **Application Information**

Title : METHOD AND SYSTEM FOR ELECTRICALLY  
COUPLING A CHIP TO CHIP PACKAGE  
Total Drawing Sheets : 3  
Formal Drawings : YES  
Application Type : Utility  
Attorney Docket Number : 501039.04  
Assigned : Yes (Large Entity)

### **Representative Information**

Representative Customer No. : 27,076

### **Continuity Information**

This application is a : divisional of  
Application One : 09/978,983  
Filing Date : October 15, 2001